### MRI System/MRI システム

### **Board-to-Board for Internal Connection**

#### Interface for Power





# IT5 3 Piece BGA Connector 25Gbps High Speed Transmission Stacking Height: 14-40mm No. of Pos.: 100, 200, 300



FX20
Floating Connector
Pitch: 0.5mm
Rated Current: 0.5A
Stacking Height:
15-30mm
No. of Pos.: 20-140



## FX23/FX23L Floating Connector 16Gbps High Speed Transmission Pitch: 0.5mm Stacking Height: 8-30mm

No. of Pos.: 20-120 (Signal) 4 (Power)



16Gbps High Speed Transmission Pitch: 0.8mm Rated Current: 0.5A/Signal

3A/Power No. of Pos.: 40-180



IP68
No. of Pos.: 3, 5
Rated Current: 38A Max.

**HR41** 

### **Non-Magnetic**



### **MRF14**

Low Insertion Force High Mating Durability (60,000 times) Frequency: 1GHz Max.

50Ω

RF Unit: 4, 8 Channels Signal Unit: 14pos./Unit Max.



### $\frac{\text{MRF18}}{\text{Small and Light Weight}}$ Frequency: 2GHz Max. $50\Omega$

8 Channels



H.FL
Non-Magnetic = H.FL/S-\*\*
Frequency: 2GHz Max.
50Ω
Mating Durability:
50 times

### **Wire-to-Board for Power**



DF60
Pitch: 10.16mm
No. of Pos.: 1-6
Rated Current: 65A Max.\*

\*Derating Curve, Ambient Temperature of 25℃





DF22
Pitch: 7.92mm
No. of Pos.: 1-5
Rated Current: 30A Max.





DF33C Pitch: 3.3mm No. of Pos.: 2-12 Rated Current: 5A Max.

